

Dual N-channel 40 V, 19.5 mΩ logic level MOSFET

16 March 2016

Product data sheet

1. General description

Dual logic level N-channel MOSFET in an LFPAK56D (Dual Power-SO8) package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

2. Features and benefits

- Dual MOSFET
- Q101 Compliant
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating
- True logic level gate with $V_{GS(th)}$ rating of greater than 0.5 V at 175 $^\circ\text{C}$

3. Applications

- 12 V Automotive systems
- Motors, lamps and solenoid control
- Transmission control
- Ultra high performance power switching

4. Quick reference data

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	40	V
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	30	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	38	W
Static characte	eristics FET1 and FET2					
R _{DSon}	drain-source on-state resistance	V _{GS} = 5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 12</u>	-	17.1	19.5	mΩ
Dynamic chara	acteristics FET1 and FE	T2				
Q _{GD}	gate-drain charge	I _D = 10 A; V _{DS} = 32 V; V _{GS} = 10 V; T _j = 25 °C; <u>Fig. 14</u>	-	3	-	nC

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Pinning information 5.

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source1	8 7 6 5	D1 D1 D2 D2
2	G1	gate1		
3	S2	source2	\bigcirc	
4	G2	gate2		
5	D2	drain2		 S1 G1 S2 G2
6	D2	drain2		mbk725
7	D1	drain1	1 2 3 4 LFPAK56D (SOT1205)	
8	D1	drain1	(0011200)	

Ordering information 6.

Table 3. Ordering inf	formation				
Type number	Package				
	Name	Description	Version		
BUK9K18-40E	LFPAK56D	Plastic single ended surface mounted package (LFPAK56D); 8 leads	SOT1205		

Marking 7.

Table 4. Marking codes	
Type number	Marking code
BUK9K18-40E	91840E

Limiting values 8.

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	40	V
V _{DGR}	drain-gate voltage	25 °C \leq T _j \leq 175 °C; R _{GS} = 20 k Ω		-	40	V
V _{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	10	V
		Pulsed; T _j ≤ 175 °C	[1][2]	-15	15	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	38	W
I _D	drain current	V _{GS} = 5 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	30	А
		V _{GS} = 5 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	24	А
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Symbol	Parameter	Conditions		Min	Мах	Unit
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 3		-	124	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drain	n diode FET1 and FET2					
I _S	source current	T _{mb} = 25 °C		-	30	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^\circ C$		-	124	А
Avalanche R	Ruggedness FET1 and FET2					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$I_D = 30 \text{ A}; V_{sup} \le 40 \text{ V}; V_{GS} = 5 \text{ V};$ $T_{j(init)} = 25 \text{ °C}; Fig. 4$	[3][4]	-	22	mJ

Accumulated Pulse duration up to 50 hours delivers zero defect ppm [1]

[2] Significantly longer life times are achieved by lowering T_j and or V_{GS} .

[3] [4] Refer to application note AN10273 for further information

Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

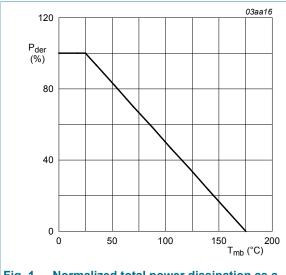
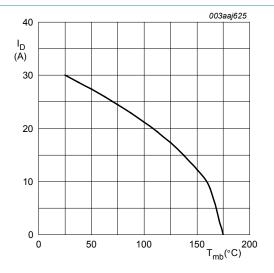


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

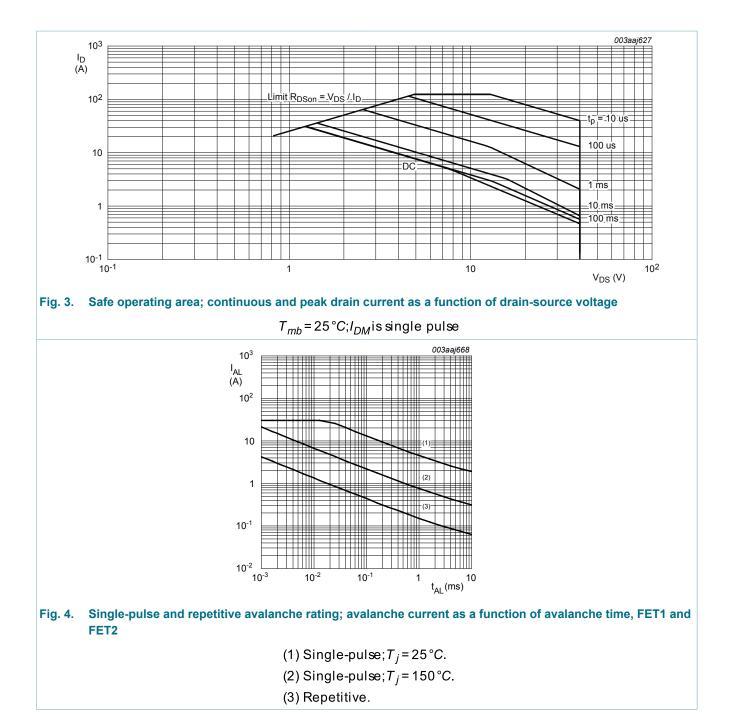




 $V_{GS} \ge 5V$

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9. Thermal characteristics

Table 6. The	rmal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	3.96	K/W

1

t_p(s)

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10⁻¹

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit		
R _{th(j-a)}	thermal resistance from junction to ambient	e Minimum footprint; mounted on a printed circuit board		from junction to printed circuit board		-	95		K/W
10 ⊨					0	03aaj683			
Z _{th(j-mb)} (K/W)	δ = 0.5								
1	0.2								
-	0.05								
10 ⁻¹				P	δ Γ Γ				

10⁻³

10⁻²

Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

10-4

10. Characteristics

10⁻²

single shot

10⁻⁵

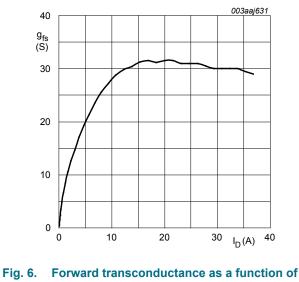
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics FET1 and FET2	· · ·				
V _{(BR)DSS}	drain-source	I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C	36	-	-	V
	breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	40	-	-	V
	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; Fig. 10; Fig. 11	1.4	1.7	2.1	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 10; Fig. 11	0.5	-	-	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; Fig. 10; Fig. 11	-	-	2.45	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μA
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
I _{GSS}	gate leakage current	V_{GS} = -10 V; V_{DS} = 0 V; T_j = 25 °C	-	2	100	nA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 5 V; I _D = 10 A; T _j = 25 °C; <u>Fig. 12</u>	-	17.1	19.5	mΩ
	resistance	V _{GS} = 5 V; I _D = 10 A; T _j = 175 °C; Fig. 12; Fig. 13	-	34.37	39.2	mΩ

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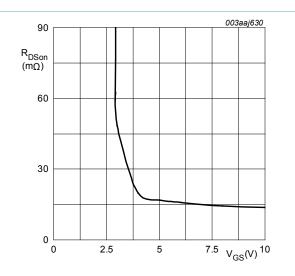
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		V _{GS} = 10 V; I _D = 10 A; T _j = 25 °C;	-	13.5	16	mΩ
		<u>Fig. 12</u>				
Dynamic cl	haracteristics FET1 and FE	T2			·	
Q _{G(tot)}	total gate charge	I_D = 10 A; V_{DS} = 32 V; V_{GS} = 10 V;	-	14.5	-	nC
		T _j = 25 °C; <u>Fig. 14; Fig. 15</u>				
Q _{GS}	gate-source charge	$I_{D} = 10 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V};$ $T_{j} = 25 \text{ °C}; \frac{\text{Fig. 14}}{2}$	-	2	-	nC
Q _{GD}	gate-drain charge		-	3	-	nC
C _{iss}	input capacitance	V_{DS} = 25 V; V_{GS} = 0 V; f = 1 MHz;	-	796	1061	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>	-	137	164	pF
C _{rss}	reverse transfer capacitance		-	82	112	pF
t _{d(on)}	turn-on delay time	V_{DS} = 32 V; R _L = 3.3 Ω; V _{GS} = 10 V;	-	4	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C	-	4.6	-	ns
t _{d(off)}	turn-off delay time		-	17.5	-	ns
t _f	fall time		-	9.9	-	ns
Source-dra	in diode FET1 and FET2	· · · · · ·	I	I		
V _{SD}	source-drain voltage	I_{S} = 10 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 17</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	I _S = 10 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V;	-	8.3	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C	-	16.2	-	nC



drain current; typical values

 $T_j = 25^{\circ}C; V_{DS} = 5V$

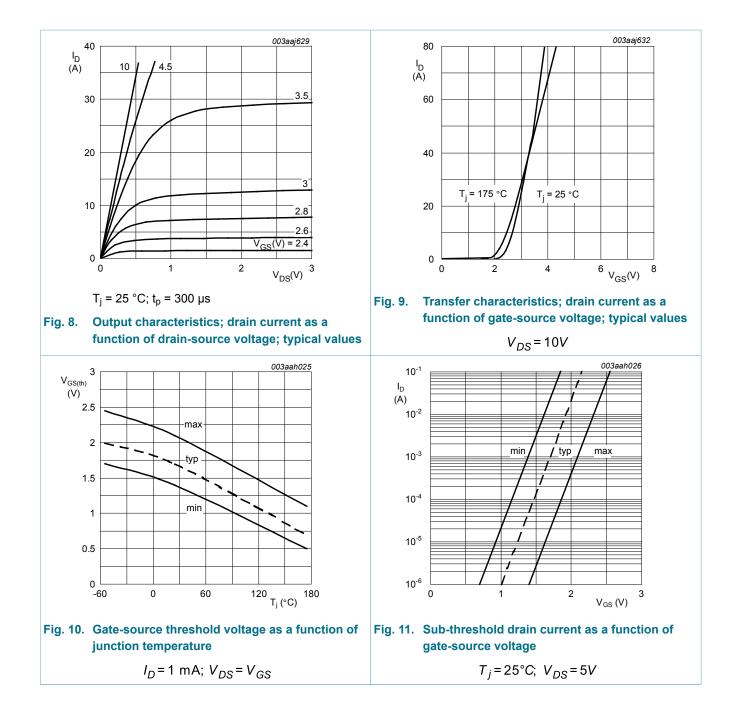




 $T_{i} = 25^{\circ}C; I_{D} = 10A$

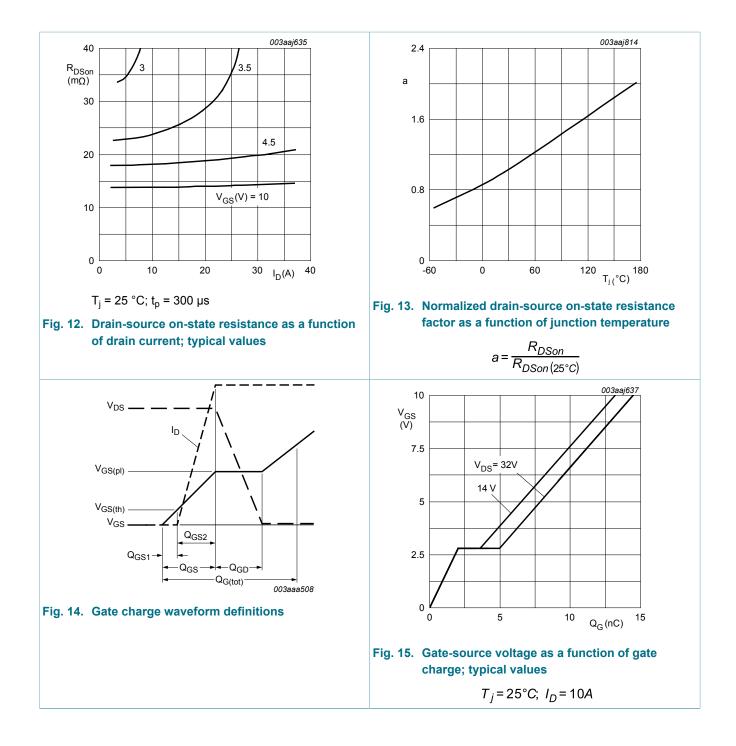
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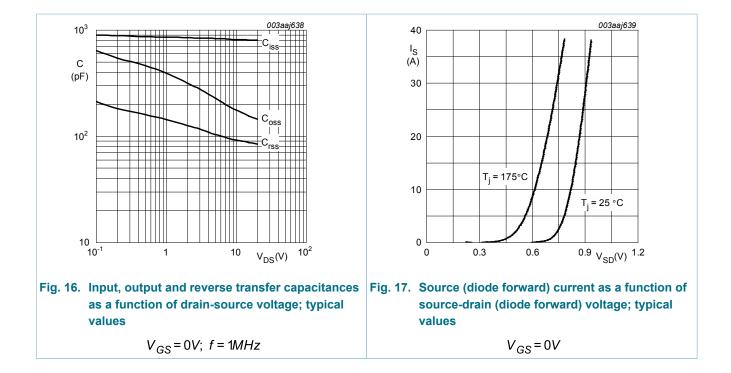
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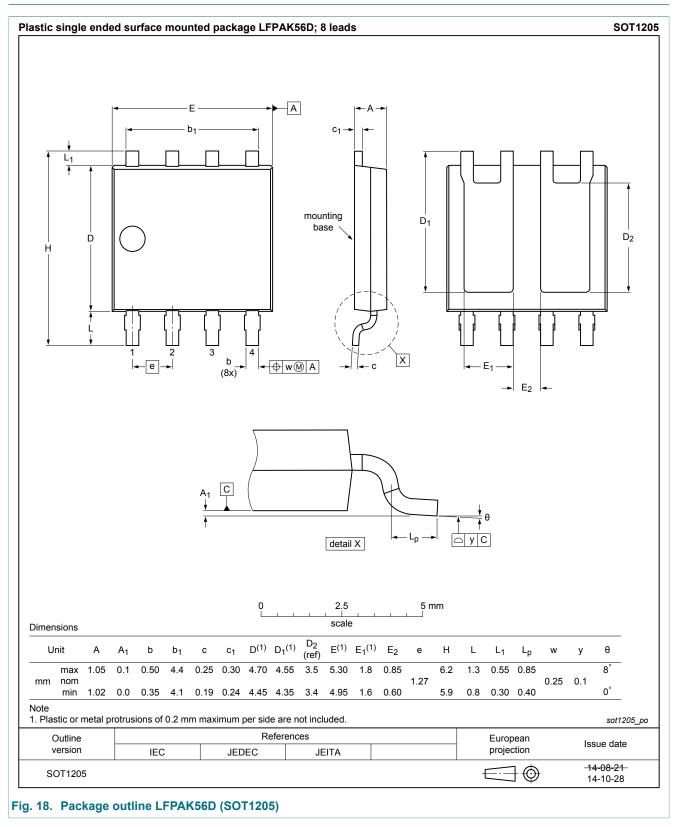
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11. Package outline



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Product data sheet

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